

晶圆级甲酸回焊炉

SRS30V Fluxless Reflow System

【功能特色】

- 全制程真空腔体中运行
- 具含氧量控知模块
- 框架式晶圆移动平台
- 上下双区温控热源
- 晶圆高度可调整
- 8/12寸自动切换，无需更换治具(可支援至4寸晶圆)

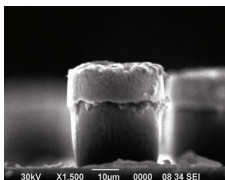


【产品优势】

- 节省氮气使用成本
- 解决锡球二次氧化
- 解决锡球内部孔洞及溅锡问题
- 减少 Particle 产生，延长维保周期
- 高良率及高产出率



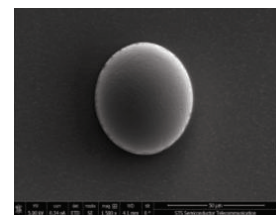
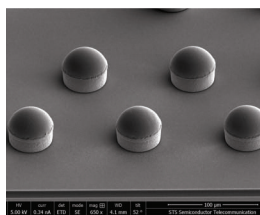
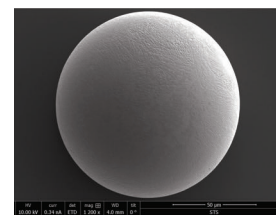
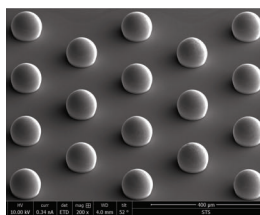
Solder Bump



CU Pillar



Reflow



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